

# 100Gbps QSFP28 ER4 Lite 40Km with FEC Hot Pluggable, Duplex LC, Single Mode PQSFP28-2541SF

#### **Features**

- ♦ Hot pluggable QSFP28 MSA form factor
- ♦ Compliant to IEEE 802.3ba 100GBASE-ER4
- ♦ Up to 30km reach for G.652 SMF without FEC
- ♦ Up to 40km reach for G.652 SMF with FEC
- ◆ Duplex LC receptacle
- ♦ 4x25Gb/s DFB-based LAN-WDM Cooling transmitter
- ♦ 4x25Gb/s APD ROSA
- ◆ 4x28G Electrical Serial Interface (CEI-28G-VSR)
- ♦ Single +3.3V power supply
- ♦ Power dissipation < 4.5W
- ♦ Operating case temperature: 0~70°C
- ♦ RoHS-6 compliant

#### **Applications**

- ♦ 100GBASE-ER4 Ethernet Links
- ♦ Infiniband QDR and DDR interconnects
- ♦ Client-side 100G Telecom connections

#### **Ordering Information**

Part Number	Product Description
PQSFP28-2541SF	100G QSFP28 ER4 Lite 40Km with FEC

#### **Overview**

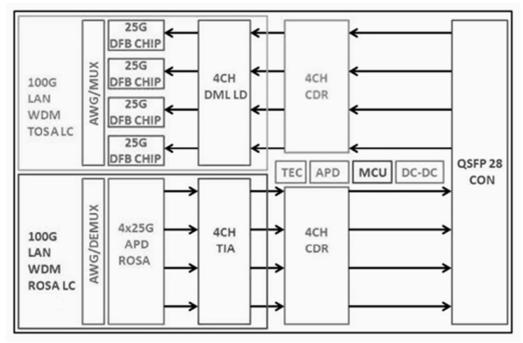
PQSFP28-2541SF a 100Gb/s transceiver module designed for optical communication applications compliant to 100GBASE-ER4 Lite standard. The module converts 4 input channels of 25Gb/s electrical data to 4 channels of LAN WDM optical signals and then multiplexes them into a single channel for 100Gb/s optical transmission. Reversely on the receiver side, the module de-multiplexes a 100Gb/s optical input into 4 channels of LAN WDM optical signals and then converts them to 4 output channels of electrical data.



The central wavelengths of the 4 LAN WDM channels are 1295.56, 1300.05, 1304.58 and 1309.14 nm as members of the LAN WDM wavelength grid defined in IEEE 802.3ba. The high performance cooled LAN WDM DFB transmitters and high sensitivity APD receivers provide superior performance for 100Gigabit Ethernet applications up to 30km links without FEC and up to 40km links with FEC interconnections.

The product is designed with form factor, optical/electrical connection and digital diagnostic interface according to the QSFP+ Multi-Source Agreement (MSA). It has been designed to meet the harshest external operating conditions including temperature, humidity and EMI interference.

#### **Module Block Diagram**



**Functional Block Diagram** 

#### **Absolute Maximum Ratings**

It has to be noted that operation in excess of any individual absolute maximum ratings might cause permanent damage to this module.

Parameter	Symbol	Min	Max	Unit
Supply Voltage	$V_{CC}$	-0.5	3.6	V
Storage Temperature	Tst	-40	85	ōC
Case Operating Temperature	Тор	0	70	ōС
Humidity (non-condensing)	RH	0	85	%
Damage Threshold, each Lane	THd	-3.0		dBm



# **Recommended Operating Conditions**

Parameter		Symbol	Min	Typical	Max	Unit
Supply Voltage		$V_{CC}$	3.135	3.3	3.465	V
Supply Current		I <sub>CC</sub>			1.36	А
Operating Case temperature		Тор	0		70	ōC
Data Rate		DR		103.125		Gbps
Power Consumption		Р			4.5	W
Link Distance with G.652	Without FEC				30	km
	With FEC	D			40	km

# **Electrical Specifications**

Parameter	Test Point	Min	Typical	Max	Unit	Notes	
Power Consumption				4.5	W		
Supply Current	Icc			1.36	Α		
Supply Voltage	$V_{CC}$	3.135	3.3	3.465	V		
		Transmitter (Eac	ch Lane)				
Input differential impedance	R <sub>IN</sub>		100		Ω	1	
Differential data input swing	V <sub>IN, PP</sub>	180		1000	mV		
Transmit Disable Voltage	$V_D$	V <sub>CC</sub> -1.3		$V_{CC}$	V		
Transmit Enable Voltage	V <sub>EN</sub>	V <sub>ee</sub>		V <sub>ee</sub> +8	V	2	
Receiver (Each Lane)							
Differential data output swing	V <sub>OUT, PP</sub>	300		850	mV	3	
LOS Fault	V <sub>LOS fault</sub>	V <sub>CC</sub> -1.3		V <sub>CC</sub> HOST	V	4	
LOS Normal	V <sub>LOS norm</sub>	V <sub>ee</sub>		V <sub>ee</sub> +8	V	4	

#### Notes:

- 1. Connected directly to TX data input pins. AC coupled thereafter
- 2. Optional for TX disable
- 3. Into 100  $\Omega$  differential termination
- 4. Loss Of Signal is LVTTL. Logic 0 indicates normal operation; logic 1 indicates no signal detected



# **Optical Characteristics**

Parameter	Symbol	Min	Typical	Max	Unit	Notes
Data Rate Each Lane	DR	2	5.78125 ±100 pp	m	Gbps	
	LO	1294.53	1295.56	1296.59	nm	
Lana Mayalangth	L1	1299.02	1300.05	1301.09	nm	
Lane Wavelength	L2	1303.54	1304.58	1305.63	nm	
	L3	1308.09	1309.14	1310.19	nm	
		Transmitt	er			
SMSR	SMSR	30			dB	
Total Average Launch Power	$P_{T}$			12.5	dBm	
Average Launch Power, each Lane	P <sub>AVG</sub>	-2.5		6.5	dBm	
OMA, each Lane	P <sub>OMA</sub>	0.5		6.5	dBm	1
Extinction Ratio	ER	4			dB	
RIN <sub>20</sub> OMA	RIN			-130	dB/Hz	
Transmitter Reflectance	$R_{T}$			-12	dB	
Eye Mask {X1, X2, X3, Y1, Y2, Y3}		{0.25, 0.4, 0.45, 0.25, 0.28, 0.4}				2
Average Launch Power OFF Transmitter, each Lane	P <sub>OFF</sub>			-30	dBm	
		Receiver	r			
Damage Threshold, each Lane	THd			-7	dBm	3
Average Deceive Devices cook Land		-16.9		-7	dBm	30km link distance
Average Receive Power, each Lane		-20.5		-7	dBm	40km link distance
Receiver Sensitivity (OMA), each Lane	SEN1			-18.5	dBm	BER = 5x10 <sup>-5</sup>
Receiver Sensitivity (OMA), each Lane	SEN2			-15	dBm	BER = $1x10^{-5}$
Stressed Receiver Sensitivity (OMA), each Lane (BER = $5x10^{-5}$ )	SEN3			-16	dBm	4
Receiver reflectance				-26	dB	
LOS Assert	LOS <sub>A</sub>	-33			dBm	
LOS De-Assert	LOS <sub>D</sub>			-23	dBm	
LOS Hysteresis	LOS <sub>H</sub>	0.5		6	dB	

#### Notes:

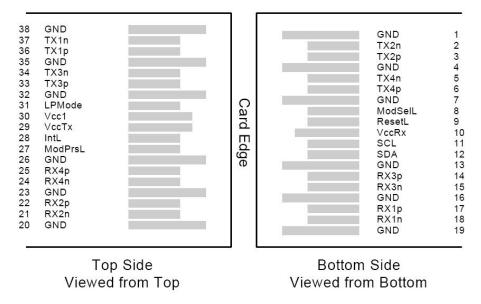
- 1. Even if the TDP < 1 dB, the OMA min must exceed the minimum value specified here
- 2. Hit ratio 5x10<sup>-5</sup>
- 3. The receiver shall be able to tolerate, without damage, continuous exposure to a modulated optical input signal having this power level on one lane. The receiver does not have to operate correctly at this input power.
- 4. Measured with conformance test signal at receiver input for BER =  $5x10^{-5}$  @25.78125Gbps.

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# **Pin Assignment**



**Electrical Pin-out Details** 

# **Pin Descriptions**

Pin	Logic	Symbol	Name/Description	Notes
1		GND	Ground	1
2	CML-I	Tx2n	Transmitter Inverted Data Input	
3	CML-I	Tx2p	Transmitter Non-Inverted Data output	
4		GND	Ground	1
5	CML-I	Tx4n	Transmitter Inverted Data Input	
6	CML-I	Tx4p	Transmitter Non-Inverted Data output	
7		GND	Ground	1
8	LVTLL-I	ModSelL	Module Select	
9	LVTLL-I	ResetL	Module Reset	
10		VccRx	+3.3V Power Supply Receiver	2
11	LVCMOS-I/O	SCL	2-Wire Serial Interface Clock	
12	LVCMOS-I/O	SDA	2-Wire Serial Interface Data	
13		GND	Ground	
14	CML-O	Rx3p	Receiver Non-Inverted Data Output	
15	CML-O	Rx3n	Receiver Inverted Data Output	
16		GND	Ground	1

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#### **PQSFP28-2541SF**

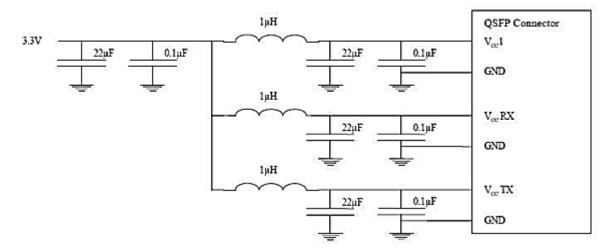
17	CML-O	Rx1p	Receiver Non-Inverted Data Output	
18	CML-O	Rx1n	Receiver Inverted Data Output	
19		GND	Ground	1
20		GND	Ground	1
21	CML-O	Rx2n	Receiver Inverted Data Output	
22	CML-O	Rx2p	Receiver Non-Inverted Data Output	
23		GND	Ground	1
24	CML-O	Rx4n	Receiver Inverted Data Output	1
25	CML-O	Rx4p	Receiver Non-Inverted Data Output	
26		GND	Ground	1
27	LVTTL-O	ModPrsL	Module Present	
28	LVTTL-O	IntL	Interrupt	
29		VccTx	+3.3 V Power Supply transmitter	2
30		Vcc1	+3.3 V Power Supply	2
31	LVTTL-I	LPMode	Low Power Mode	
32		GND	Ground	1
33	CML-I	Тх3р	Transmitter Non-Inverted Data Input	
34	CML-I	Tx3n	Transmitter Inverted Data Output	
35		GND	Ground	1
36	CML-I	Tx1p	Transmitter Non-Inverted Data Input	
37	CML-I	Tx1n	Transmitter Inverted Data Output	
38		GND	Ground	1

#### Notes:

- 1. GND is the symbol for signal and supply power) common for the QSFP28 module. All are common within the module and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal common ground plane.
- 2.  $V_{CC}Rx$ ,  $V_{CC}Tx$  are applied concurrently and may be internally connected within the module in any combination.  $V_{CC}$  contacts in SFF-8662 and SFF-8672 each have a steady state current rating of 1 A

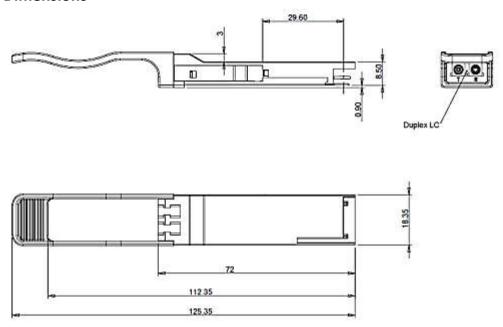


# **Power Supply Filter**



Host Board Power Supply Filter

# **Mechanical Dimensions**



**Mechanical Specifications**